



### Dimensions

Footprint	3216
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
H	1.6mm +/-0.2mm
S	0.8mm +/-0.3mm
F	1.2mm +/-0.1mm
K	1.3mm TYP

### Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	9000

### General Information

Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, Molded, High Temperature
Features	High Temperature, Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Notes	Obsolete.

### Specifications

Capacitance	1 uF
Capacitance Tolerance	10%
Voltage DC	16 VDC (85C), 12.75 VDC (125C), 10.72 VDC (150C)
Temperature Range	-55/+150°C
Rated Temperature	85°C
Dissipation Factor	3%
Failure Rate	N/A
ESR	6.5 Ohms (100kHz)
Ripple Current	107.4 mAmps (25C), 96.7 mAmps (85C), 43 mAmps (125C)
Leakage Current	0.5 uA